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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

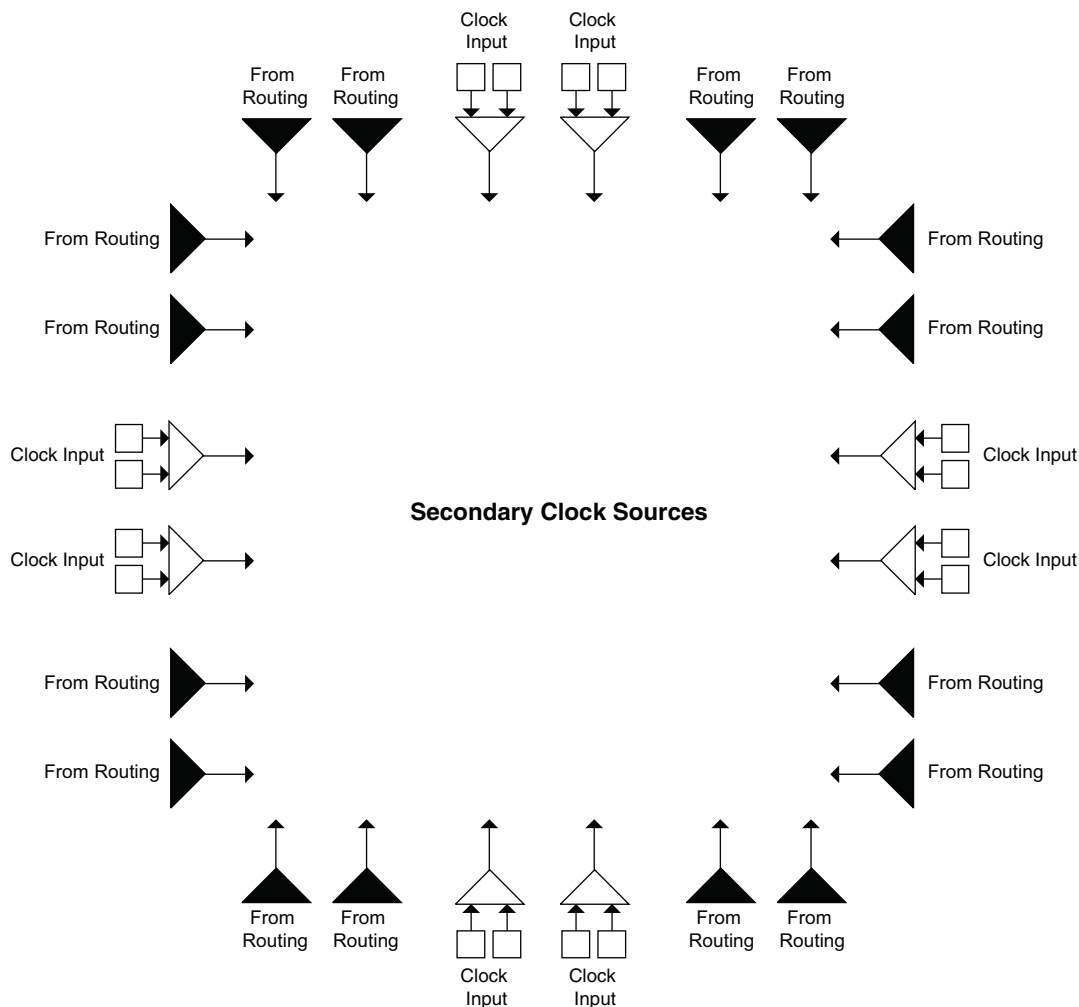
Details

Product Status	Obsolete
Number of LABs/CLBs	8500
Number of Logic Elements/Cells	68000
Total RAM Bits	1056768
Number of I/O	500
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-70se-6f672c

Secondary Clock/Control Sources

LatticeECP2/M devices derive secondary clocks (SC0 through SC7) from eight dedicated clock input pads and the rest from routing. Figure 2-11 shows the secondary clock sources.

Figure 2-11. Secondary Clock Sources



IPexpress™

The user can access the sysDSP block via the IPexpress tool, which provides the option to configure each DSP module (or group of modules) or by direct HDL instantiation. In addition, Lattice has partnered with The MathWorks® to support instantiation in the Simulink® tool, a graphical simulation environment. Simulink works with Diamond to dramatically shorten the DSP design cycle in Lattice FPGAs.

Optimized DSP Functions

Lattice provides a library of optimized DSP IP functions. Some of the IP cores planned for the LatticeECP2/M DSP include the Bit Correlator, Fast Fourier Transform, Finite Impulse Response (FIR) Filter, Reed-Solomon Encoder/Decoder, Turbo Encoder/Decoder and Convolutional Encoder/Decoder. Please contact Lattice to obtain the latest list of available DSP IP cores.

Resources Available in the LatticeECP2/M Family

Table 2-9 shows the maximum number of multipliers for each member of the LatticeECP2/M family. Table 2-10 shows the maximum available EBR RAM Blocks in each LatticeECP2/M device. EBR blocks, together with Distributed RAM can be used to store variables locally for fast DSP operations.

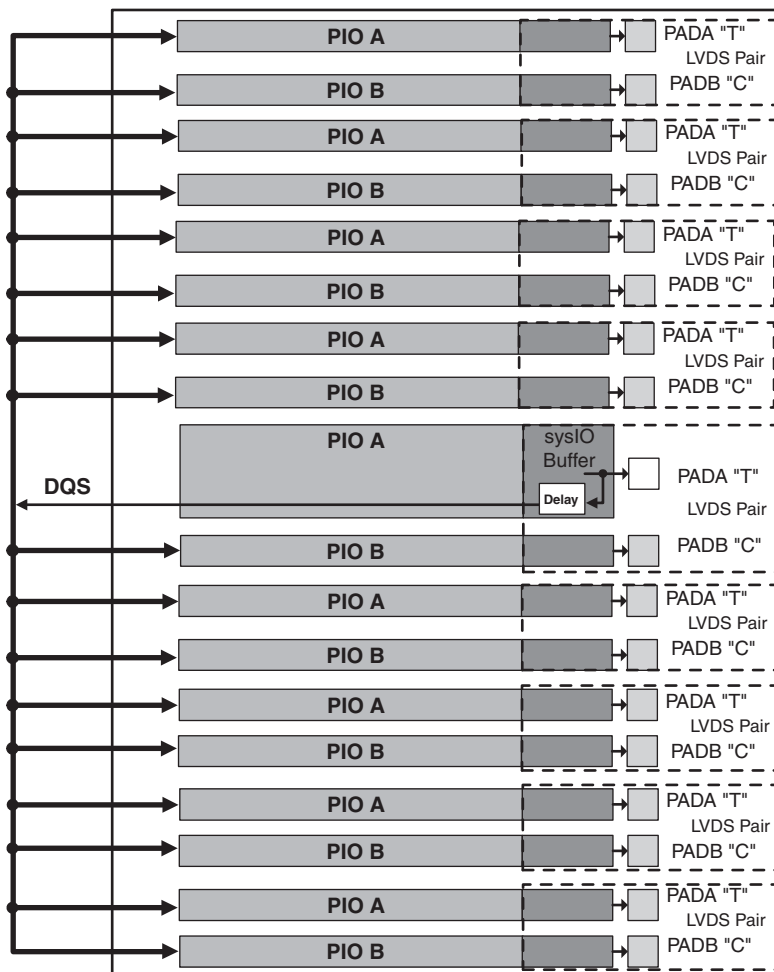
Table 2-9. Maximum Number of DSP Blocks in the LatticeECP2/M Family

Device	DSP Block	9x9 Multiplier	18x18 Multiplier	36x36 Multiplier
ECP2-6	3	24	12	3
ECP2-12	6	48	24	6
ECP2-20	7	56	28	7
ECP2-35	8	64	32	8
ECP2-50	18	144	72	18
ECP2-70	22	176	88	22
ECP2M20	6	48	24	6
ECP2M35	8	64	32	8
ECP2M50	22	176	88	22
ECP2M70	24	192	96	24
ECP2M100	42	336	168	42

Table 2-10. Embedded SRAM in the LatticeECP2/M Family

Device	EBR SRAM Block	Total EBR SRAM (Kbits)
ECP2-6	3	55
ECP2-12	12	221
ECP2-20	15	277
ECP2-35	18	332
ECP2-50	21	387
ECP2-70	60	1106
ECP2M20	66	1217
ECP2M35	114	2101
ECP2M50	225	4147
ECP2M70	246	4534
ECP2M100	288	5308

Figure 2-34. DQS Input Routing for the Bottom Edge of the Device



DLL Calibrated DQS Delay Block

Source synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However, in DDR memories the clock (referred to as DQS) is not free-running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only, as shown in Figure 2-35) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figure 2-35 and Figure 2-36 show how the DQS transition signals are routed to the PIOs.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two dedicated DLLs (DDR_DLL) on opposite sides of the device. Each DLL compensates DQS delays in its half of the device as shown in Figure 2-35. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

LVDS25E

The top and bottom sides of LatticeECP2/M devices support LVDS outputs via emulated complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in Figure 3-1 is one possible solution for point-to-point signals.

Figure 3-1. LVDS25E Output Termination Example

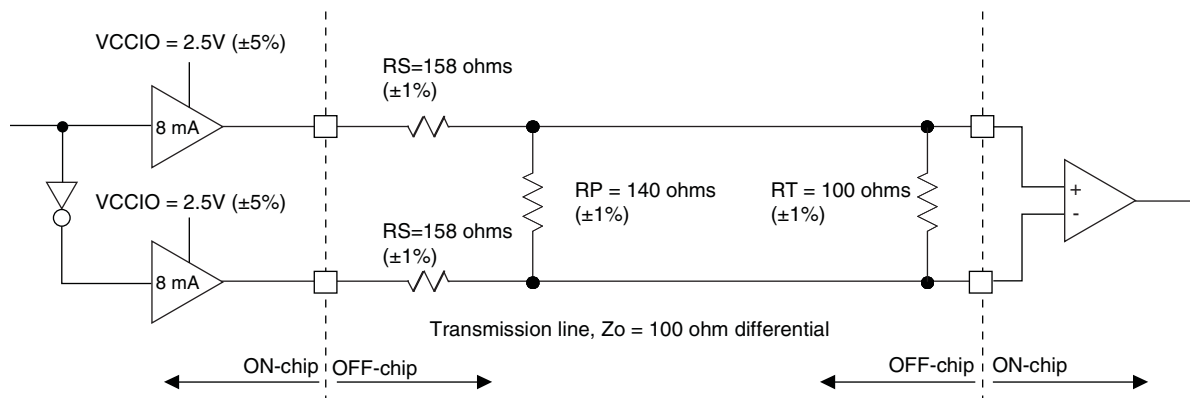


Table 3-2. LVDS25E DC Conditions

Parameter	Description	Typical	Units
V _{CCIO}	Output Driver Supply (+/-5%)	2.50	V
Z _{OUT}	Driver Impedance	20	Ω
R _S	Driver Series Resistor (+/-1%)	158	Ω
R _P	Driver Parallel Resistor (+/-1%)	140	Ω
R _T	Receiver Termination (+/-1%)	100	Ω
V _{OH}	Output High Voltage	1.43	V
V _{OL}	Output Low Voltage	1.07	V
V _{OD}	Output Differential Voltage	0.35	V
V _{CM}	Output Common Mode Voltage	1.25	V
Z _{BACK}	Back Impedance	100.5	Ω
I _{DC}	DC Output Current	6.03	mA

LVCMOS33D

All I/O banks support emulated differential I/O using the LVCMOS33D I/O type. This option, along with the external resistor network, provides the system designer the flexibility to place differential outputs on an I/O bank with 3.3V VCCIO. The default drive current for LVCMOS33D output is 12mA with the option to change the device strength to 4mA, 8mA, 16mA or 20mA. Follow the LVCMOS33 specifications for the DC characteristics of the LVCMOS33D.

LVPECL

The LatticeECP2/M devices support the differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

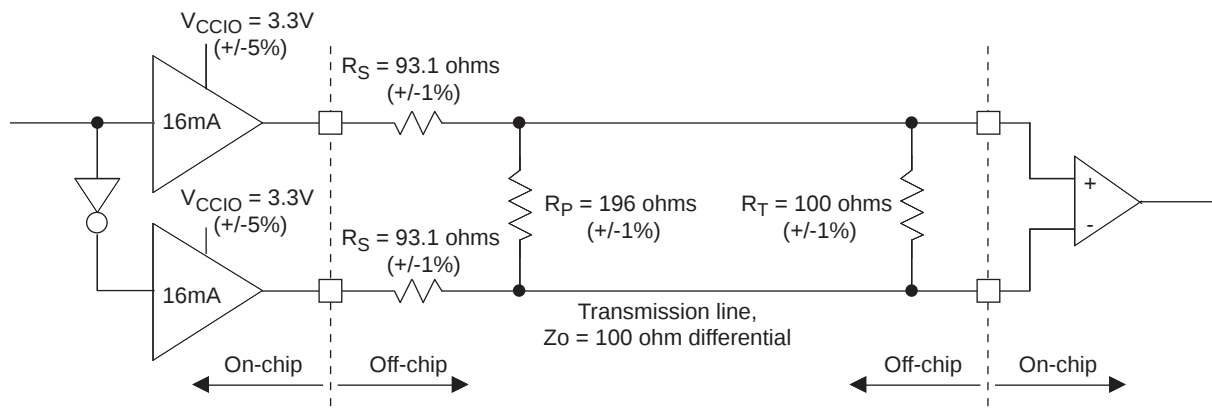


Table 3-4. LVPECL DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
V_{CCIO}	Output Driver Supply (+/-5%)	3.30	V
Z_{OUT}	Driver Impedance	10	Ω
R_S	Driver Series Resistor (+/-1%)	93	Ω
R_P	Driver Parallel Resistor (+/-1%)	196	Ω
R_T	Receiver Termination (+/-1%)	100	Ω
V_{OH}	Output High Voltage	2.05	V
V_{OL}	Output Low Voltage	1.25	V
V_{OD}	Output Differential Voltage	0.80	V
V_{CM}	Output Common Mode Voltage	1.65	V
Z_{BACK}	Back Impedance	100.5	Ω
I_{DC}	DC Output Current	12.11	mA

1. For input buffer, see LVDS table.

Table 3-18. Reference Clock

Symbol	Description	Test Conditions	Min.	Typ.	Max.	Units
F_{REFCLK}	Reference clock frequency		—	100	—	MHz
V_{CM}	Input common mode voltage		—	0.65	—	V
T_R/T_F	Clock input rise/fall time		—	—	1.0	ns
V_{SW}	Differential input voltage swing		0.6	—	1.6	V
DC_{REFCLK}	Input clock duty cycle		40	50	60	%
PPM	Reference clock tolerance		-300	—	+300	ppm

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
$t_{HCB DI}$	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay ¹	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port²				
t_{CFGX}	INITN High to CCLK Low	—	1	μs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

Available Device Resources by Package, LatticeECP2

Resource	Device	256 fpBGA	484 fpBGA	672 fpBGA	900 fpBGA
PLL/DLL	ECP2-6	4	—	—	—
	ECP2-12	4	4	—	—
	ECP2-20	4	4	4	—
	ECP2-35	—	4	4	—
	ECP2-50	—	6	6	—
	ECP2-70	—	—	8	8

Available Device Resources by Package, LatticeECP2M

Resource	Device	256 fpBGA	484 fpBGA	672 fpBGA	900 fpBGA	1152 fpBGA
PLL/DLL	ECP2M20	10	10	—	—	—
	ECP2M35	10	10	10	—	—
	ECP2M50	—	10	10	10	—
	ECP2M70	—	—	—	10	10
	ECP2M100	—	—	—	10	10

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A6	PT21A	0		T	PT30A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
C7	PT17B	0		C	PT26B	0		C	
D10	PT18B	0		C	PT27B	0		C	
C6	PT17A	0		T	PT26A	0		T	
E10	PT18A	0		T	PT27A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
F10	PT15B	0		C	PT24B	0		C	
B6	PT16B	0		C	PT25B	0		C	
D9	PT15A	0		T	PT24A	0		T	
B5	PT16A	0		T	PT25A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
A5	PT13B	0		C	PT22B	0		C	
F9	PT14B	0		C	PT23B	0		C	
A4	PT13A	0		T	PT22A	0		T	
E9	PT14A	0		T	PT23A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
G8	PT11B	0		C	PT20B	0		C	
A3	PT12B	0		C	PT21B	0		C	
E8	PT11A	0		T	PT20A	0		T	
A2	PT12A	0		T	PT21A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
-	-	-			VCCIO0	0			
C3	PT10B	0		C	PT10B	0		C	
B3	PT10A	0		T	PT10A	0		T	
-	-	-			GNDIO0	-			
E7	PT8B	0		C	PT8B	0		C	
F8	PT9B	0		C	PT9B	0		C	
F7	PT8A	0		T	PT8A	0		T	
D7	PT9A	0		T	PT9A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
D4	PT6B	0		C	PT6B	0		C	
D5	PT7B	0		C	PT7B	0		C	
C4	PT6A	0		T	PT6A	0		T	
D6	PT7A	0		T	PT7A	0		T	
GNDIO	GNDIO0	-			GNDIO	-			
J7	PT4B	0		C	PT4B	0		C	
B2	PT5B	0		C	PT5B	0		C	
H7	PT4A	0		T	PT4A	0		T	
B1	PT5A	0		T	PT5A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
D1	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
D3	PT3B	0		C	PT3B	0		C	
C1	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C8	PT29B	0		C	PT38B	0		C
D8	PT29A	0		T	PT38A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
D10	PT27B	0		C	PT36B	0		C
E10	PT27A	0		T	PT36A	0		T
C7	PT26B	0		C	PT35B	0		C
C6	PT26A	0		T	PT35A	0		T
VCCIO	VCCIO0	0			VCCIO	0		
B6	PT25B	0		C	PT34B	0		C
B5	PT25A	0		T	PT34A	0		T
F10	PT24B	0		C	PT33B	0		C
D9	PT24A	0		T	PT33A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
F9	PT23B	0		C	PT32B	0		C
E9	PT23A	0		T	PT32A	0		T
A5	PT22B	0		C	PT31B	0		C
A4	PT22A	0		T	PT31A	0		T
VCCIO	VCCIO0	0			VCCIO	0		
A3	PT21B	0		C	PT30B	0		C
A2	PT21A	0		T	PT30A	0		T
G8	PT20B	0		C	PT29B	0		C
E8	PT20A	0		T	PT29A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
VCCIO	VCCIO0	0			VCCIO	0		
C3	PT10B	0		C	PT10B	0		C
B3	PT10A	0		T	PT10A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
F8	PT9B	0		C	PT9B	0		C
D7	PT9A	0		T	PT9A	0		T
E7	PT8B	0		C	PT8B	0		C
VCCIO	VCCIO0	0			VCCIO	0		
F7	PT8A	0		T	PT8A	0		T
D5	PT7B	0		C	PT7B	0		C
D6	PT7A	0		T	PT7A	0		T
D4	PT6B	0		C	PT6B	0		C
C4	PT6A	0		T	PT6A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
B2	PT5B	0		C	PT5B	0		C
B1	PT5A	0		T	PT5A	0		T
J7	PT4B	0		C	PT4B	0		C
VCCIO	VCCIO0	0			VCCIO	0		
H7	PT4A	0		T	PT4A	0		T
D3	PT3B	0		C	PT3B	0		C
C2	PT3A	0		T	PT3A	0		T
D1	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
C1	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K1	PL27B	7	LDQ29	C (LVDS)*
K5	PL28A	7	LDQ29	T
K7	PL28B	7	LDQ29	C
GND	GNDIO7	-		
K4	PL29A	7	LDQS29	T (LVDS)*
K3	PL29B	7	LDQ29	C (LVDS)*
L8	PL30A	7	LDQ29	T
VCCIO	VCCIO7	7		
L6	PL30B	7	LDQ29	C
L2	PL31A	7	LDQ29	T (LVDS)*
L1	PL31B	7	LDQ29	C (LVDS)*
L7	PL32A	7	LDQ29	T
GND	GNDIO7	-		
L5	PL32B	7	LDQ29	C
L4	PL33A	7	LDQ37	T (LVDS)*
L3	PL33B	7	LDQ37	C (LVDS)*
M8	PL34A	7	LDQ37	T
M6	PL34B	7	LDQ37	C
VCCIO	VCCIO7	7		
M2	PL35A	7	LDQ37	T (LVDS)*
M1	PL35B	7	LDQ37	C (LVDS)*
M7	PL36A	7	LDQ37	T
M5	PL36B	7	LDQ37	C
GND	GNDIO7	-		
M4	PL37A	7	LDQS37	T (LVDS)*
M3	PL37B	7	LDQ37	C (LVDS)*
N6	PL38A	7	LUM0_SPLLT_IN_A/LDQ37	T
VCCIO	VCCIO7	7		
N8	PL38B	7	LUM0_SPLLC_IN_A/LDQ37	C
N5	PL39A	7	LUM0_SPLLT_FB_A/LDQ37	T
N7	PL39B	7	LUM0_SPLLC_FB_A/LDQ37	C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
T9	PL50A	7	LDQ54	
R9	PL51A	7	LDQ54	T
P7	PL51B	7	LDQ54	C
VCCIO	VCCIO7	7		
N2	PL52A	7	LDQ54	T (LVDS)*
N1	PL52B	7	LDQ54	C (LVDS)*
P6	PL53A	7	LDQ54	T
P5	PL53B	7	LDQ54	C
GND	GNDIO7	-		
P4	PL54A	7	LDQS54	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P3	PL54B	7	LDQ54	C (LVDS)*
R6	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7		
R8	PL55B	7	LDQ54	C
P2	PL56A	7	LDQ54	T (LVDS)*
P1	PL56B	7	LDQ54	C (LVDS)*
R5	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-		
R7	PL57B	7	PCLKC7_0/LDQ54	C
R4	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
R3	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
T5	PL60A	6	VREF2_6/LDQ63	T
T7	PL60B	6	VREF1_6/LDQ63	C
T3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
T4	PL61B	6	LDQ63	C (LVDS)*
T6	PL62A	6	LDQ63	T
T8	PL62B	6	LDQ63	C
T2	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-		
T1	PL63B	6	LDQ63	C (LVDS)*
U7	PL64A	6	LDQ63	T
U5	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6		
U4	PL65A	6	LDQ63	T (LVDS)*
U3	PL65B	6	LDQ63	C (LVDS)*
U8	PL66A	6	LDQ63	T
U6	PL66B	6	LDQ63	C
GND	GNDIO6	-		
U2	PL67A	6	LDQ71	T (LVDS)*
U1	PL67B	6	LDQ71	C (LVDS)*
V7	PL68A	6	LDQ71	T
V5	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
V2	PL69A	6	LDQ71	T (LVDS)*
V1	PL69B	6	LDQ71	C (LVDS)*
V8	PL70A	6	LDQ71	T
V6	PL70B	6	LDQ71	C
GND	GNDIO6	-		
W1	PL71A	6	LDQS71	T (LVDS)*
W2	PL71B	6	LDQ71	C (LVDS)*
W5	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ6	PB16A	5	BDQ15	T
AK6	PB16B	5	BDQ15	C
VCCIO	VCCIO5	5		
GND	GNDIO5	-		
AD10	PB29A	5	BDQ33	T
AF10	PB29B	5	BDQ33	C
AC11	PB30A	5	BDQ33	T
AD11	PB30B	5	BDQ33	C
AG9	PB31A	5	BDQ33	T
AH9	PB31B	5	BDQ33	C
VCCIO	VCCIO5	99		
AE11	PB32A	5	BDQ33	T
AG10	PB32B	5	BDQ33	C
GND	GNDIO5	-		
AJ9	PB33A	5	BDQS33	T
AK9	PB33B	5	BDQ33	C
AF11	PB34A	5	BDQ33	T
AH10	PB34B	5	BDQ33	C
AC12	PB35A	5	BDQ33	T
AE12	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5		
AD12	PB36A	5	BDQ33	T
AF12	PB36B	5	BDQ33	C
AJ10	PB37A	5	BDQ33	T
AK10	PB37B	5	BDQ33	C
GND	GNDIO5	-		
AG11	PB38A	5	BDQ42	T
AH11	PB38B	5	BDQ42	C
AE13	PB39A	5	BDQ42	T
AC13	PB39B	5	BDQ42	C
AF13	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5		
AD13	PB40B	5	BDQ42	C
AJ11	PB41A	5	BDQ42	T
AK11	PB41B	5	BDQ42	C
AD14	PB42A	5	BDQS42	T
GND	GNDIO5	-		
AC14	PB42B	5	BDQ42	C
AG12	PB43A	5	BDQ42	T
AE14	PB43B	5	BDQ42	C
AJ12	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5		
AK12	PB44B	5	BDQ42	C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P25	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2		
P23	PR51A	2	RDQ54	T
P27	PR50B	2	RDQ54	C (LVDS)*
P28	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-		
VCCIO	VCCIO2	2		
N24	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
N26	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
N23	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
N25	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2		
P29	PR37B	2	RDQ37	C (LVDS)*
P30	PR37A	2	RDQS37	T (LVDS)*
M26	PR36B	2	RDQ37	C
GND	GNDIO2	-		
M24	PR36A	2	RDQ37	T
N29	PR35B	2	RDQ37	C (LVDS)*
N30	PR35A	2	RDQ37	T (LVDS)*
M25	PR34B	2	RDQ37	C
VCCIO	VCCIO2	2		
M23	PR34A	2	RDQ37	T
M27	PR33B	2	RDQ37	C (LVDS)*
M28	PR33A	2	RDQ37	T (LVDS)*
L26	PR32B	2	RDQ29	C
GND	GNDIO2	-		
L24	PR32A	2	RDQ29	T
M29	PR31B	2	RDQ29	C (LVDS)*
M30	PR31A	2	RDQ29	T (LVDS)*
L25	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2		
L23	PR30A	2	RDQ29	T
L27	PR29B	2	RDQ29	C (LVDS)*
L28	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-		
K24	PR28B	2	RDQ29	C
K26	PR28A	2	RDQ29	T
L29	PR27B	2	RDQ29	C (LVDS)*
L30	PR27A	2	RDQ29	T (LVDS)*
VCCIO	VCCIO2	2		
K23	PR26B	2	RDQ29	C
K25	PR26A	2	RDQ29	T
K27	PR25B	2	RDQ29	C (LVDS)*

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
F11	VCCIO0	0			VCCIO0	0			
J13	VCCIO0	0			VCCIO0	0			
K12	VCCIO0	0			VCCIO0	1			
D18	VCCIO1	1			VCCIO1	1			
F16	VCCIO1	1			VCCIO1	1			
J14	VCCIO1	1			VCCIO1	1			
K15	VCCIO1	1			VCCIO1	1			
G25	VCCIO2	2			VCCIO2	2			
L21	VCCIO2	2			VCCIO2	2			
M17	VCCIO2	2			VCCIO2	2			
M25	VCCIO2	2			VCCIO2	2			
N18	VCCIO2	2			VCCIO2	2			
P18	VCCIO3	3			VCCIO3	3			
R17	VCCIO3	3			VCCIO3	3			
R25	VCCIO3	3			VCCIO3	3			
T21	VCCIO3	3			VCCIO3	3			
Y25	VCCIO3	3			VCCIO3	3			
AA16	VCCIO4	4			VCCIO4	4			
AC18	VCCIO4	4			VCCIO4	4			
U15	VCCIO4	4			VCCIO4	4			
V14	VCCIO4	4			VCCIO4	4			
AA11	VCCIO5	5			VCCIO5	5			
V13	VCCIO5	5			VCCIO5	5			
AE12	VCCIO5	5			VCCIO5	5			
AE7	VCCIO5	5			VCCIO5	5			
U12	VCCIO5	5			VCCIO5	5			
P9	VCCIO6	6			VCCIO6	6			
R10	VCCIO6	6			VCCIO6	6			
R2	VCCIO6	6			VCCIO6	6			
T6	VCCIO6	6			VCCIO6	6			
Y2	VCCIO6	6			VCCIO6	6			
G2	VCCIO7	7			VCCIO7	7			
L6	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M2	VCCIO7	7			VCCIO7	7			
N9	VCCIO7	7			VCCIO7	7			
AC24	VCCIO8	8			VCCIO8	8			
U17	VCCIO8	8			VCCIO8	8			
J11	VCCAUX	-			VCCAUX	-			
J12	VCCAUX	-			VCCAUX	-			
J15	VCCAUX	-			VCCAUX	-			
J16	VCCAUX	-			VCCAUX	-			
L18	VCCAUX	-			VCCAUX	-			
L9	VCCAUX	-			VCCAUX	-			
M18	VCCAUX	-			VCCAUX	-			
M9	VCCAUX	-			VCCAUX	-			
R18	VCCAUX	-			VCCAUX	-			
R9	VCCAUX	-			VCCAUX	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AF1	PL78B	6	LDQ82	C (LVDS)*	PL95B	6	LDQ99	C (LVDS)*
AE5	PL79A	6	LDQ82	T	PL96A	6	LDQ99	T
AE6	PL79B	6	LDQ82	C	PL96B	6	LDQ99	C
AF4	PL80A	6	LDQ82	T (LVDS)*	PL97A	6	LDQ99	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
AF3	PL80B	6	LDQ82	C (LVDS)*	PL97B	6	LDQ99	C (LVDS)*
AF5	PL81A	6	LDQ82	T	PL98A	6	LDQ99	T
AF6	PL81B	6	LDQ82	C	PL98B	6	LDQ99	C
AG1	PL82A	6	LLM0_GPLLT_IN_A**/LDQS82	T (LVDS)*	PL99A	6	LLM0_GPLLT_IN_A**/LDQS99	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
AG2	PL82B	6	LLM0_GPLLC_IN_A**/LDQ82	C (LVDS)*	PL99B	6	LLM0_GPLLC_IN_A**/LDQ99	C (LVDS)*
AE9	PL83A	6	LLM0_GPLLT_FB_A/LDQ82	T	PL100A	6	LLM0_GPLLT_FB_A/LDQ99	T
AF7	PL83B	6	LLM0_GPLLC_FB_A/LDQ82	C	PL100B	6	LLM0_GPLLC_FB_A/LDQ99	C
VCCIO	VCCIO6	6			VCCIO6	6		
AH1	PL84A	6	LLM0_GDLLT_IN_A**/LDQ82	T (LVDS)*	PL101A	6	LLM0_GDLLT_IN_A**/LDQ99	T (LVDS)*
AH2	PL84B	6	LLM0_GDLLC_IN_A**/LDQ82	C (LVDS)*	PL101B	6	LLM0_GDLLC_IN_A**/LDQ99	C (LVDS)*
AG5	PL85A	6	LLM0_GDLLT_FB_A/LDQ82	T	PL102A	6	LLM0_GDLLT_FB_A/LDQ99	T
AG4	PL85B	6	LLM0_GDLLC_FB_A/LDQ82	C	PL102B	6	LLM0_GDLLC_FB_A/LDQ99	C
GNDIO	GNDIO6	-			GNDIO6	-		
AG6	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
AJ1	PL87A	6		T	PL104A	6		T
AJ2	PL87B	6		C	PL104B	6		C
AK2	TCK	-			TCK	-		
AK1	TDI	-			TDI	-		
AL1	TMS	-			TMS	-		
AF10	TDO	-			TDO	-		
AK3	VCCJ	-			VCCJ	-		
AN2	LLC_SQ_VCCRX3	14			LLC_SQ_VCCRX3	14		
AM2	LLC_SQ_HDINP3	14		T	LLC_SQ_HDINP3	14		T
AN1	LLC_SQ_VCCIB3	14			LLC_SQ_VCCIB3	14		
AM3	LLC_SQ_HDINN3	14		C	LLC_SQ_HDINN3	14		C
AN3	LLC_SQ_VCCTX3	14			LLC_SQ_VCCTX3	14		
AP2	LLC_SQ_HDOUTP3	14		T	LLC_SQ_HDOUTP3	14		T
AM1	LLC_SQ_VCCOB3	14			LLC_SQ_VCCOB3	14		
AP3	LLC_SQ_HDOUTN3	14		C	LLC_SQ_HDOUTN3	14		C
AN4	LLC_SQ_VCCTX2	14			LLC_SQ_VCCTX2	14		
AP4	LLC_SQ_HDOUTN2	14		C	LLC_SQ_HDOUTN2	14		C
AL3	LLC_SQ_VCCOB2	14			LLC_SQ_VCCOB2	14		
AP5	LLC_SQ_HDOUTP2	14		T	LLC_SQ_HDOUTP2	14		T
AN5	LLC_SQ_VCCRX2	14			LLC_SQ_VCCRX2	14		
AM4	LLC_SQ_HDINN2	14		C	LLC_SQ_HDINN2	14		C
AL4	LLC_SQ_VCCIB2	14			LLC_SQ_VCCIB2	14		
AM5	LLC_SQ_HDINP2	14		T	LLC_SQ_HDINP2	14		T
AL6	LLC_SQ_VCCP	14			LLC_SQ_VCCP	14		
AL5	LLC_SQ_REFCLKP	14		T	LLC_SQ_REFCLKP	14		T
AK5	LLC_SQ_REFCLKN	14		C	LLC_SQ_REFCLKN	14		C
AK6	LLC_SQ_VCCAUX33	14			LLC_SQ_VCCAUX33	14		
AM6	LLC_SQ_HDINP1	14		T	LLC_SQ_HDINP1	14		T

LatticeECP2M Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5F484C	304	1.2V	-5	fpBGA	484	COM	20
LFE2M20E-6F484C	304	1.2V	-6	fpBGA	484	COM	20
LFE2M20E-7F484C	304	1.2V	-7	fpBGA	484	COM	20
LFE2M20E-5F256C	140	1.2V	-5	fpBGA	256	COM	20
LFE2M20E-6F256C	140	1.2V	-6	fpBGA	256	COM	20
LFE2M20E-7F256C	140	1.2V	-7	fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5F672C	410	1.2V	-5	fpBGA	672	COM	35
LFE2M35E-6F672C	410	1.2V	-6	fpBGA	672	COM	35
LFE2M35E-7F672C	410	1.2V	-7	fpBGA	672	COM	35
LFE2M35E-5F484C	303	1.2V	-5	fpBGA	484	COM	35
LFE2M35E-6F484C	303	1.2V	-6	fpBGA	484	COM	35
LFE2M35E-7F484C	303	1.2V	-7	fpBGA	484	COM	35
LFE2M35E-5F256C	140	1.2V	-5	fpBGA	256	COM	35
LFE2M35E-6F256C	140	1.2V	-6	fpBGA	256	COM	35
LFE2M35E-7F256C	140	1.2V	-7	fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5F900C	410	1.2V	-5	fpBGA	900	COM	50
LFE2M50E-6F900C	410	1.2V	-6	fpBGA	900	COM	50
LFE2M50E-7F900C	410	1.2V	-7	fpBGA	900	COM	50
LFE2M50E-5F672C	372	1.2V	-5	fpBGA	672	COM	50
LFE2M50E-6F672C	372	1.2V	-6	fpBGA	672	COM	50
LFE2M50E-7F672C	372	1.2V	-7	fpBGA	672	COM	50
LFE2M50E-5F484C	270	1.2V	-5	fpBGA	484	COM	50
LFE2M50E-6F484C	270	1.2V	-6	fpBGA	484	COM	50
LFE2M50E-7F484C	270	1.2V	-7	fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5F1152C	436	1.2V	-5	fpBGA	1152	COM	70
LFE2M70E-6F1152C	436	1.2V	-6	fpBGA	1152	COM	70
LFE2M70E-7F1152C	436	1.2V	-7	fpBGA	1152	COM	70
LFE2M70E-5F900C	416	1.2V	-5	fpBGA	900	COM	70
LFE2M70E-6F900C	416	1.2V	-6	fpBGA	900	COM	70
LFE2M70E-7F900C	416	1.2V	-7	fpBGA	900	COM	70

Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVCMOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
April 2008	03.1	Pinout Information	Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
June 2008	03.2	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
		Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
August 2008	03.3	DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPI _m Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t _{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.